



3mm Round, Super Bright Red Tri-Level LED CBI

# **Technical Data Sheet**

#### Features:

- Low power consumption.
- High efficiency.
- Good control and free combinations on the colors of LED lamps.
- Good lock and easy to assembly.
- Stackable and easy to assembly.
- Stackable vertically and easy to assembly.
- Stackable horizontally and easy to assembly.
- Versatile mounting on P.C board or panel.
- Black case enhances contrast ratio.
- Compliance with EU REACH.
- The product itself will remain within RoHS compliant Version .

#### **Descriptions:**

- CBI (Circuit Board Indicator) is a black plastic right angle Holder (Housing) which mates with Ever-Led LED lamps.
- Ever-Led CBI is available in a wide variety of packages, including top-view (Spacer) or right angle and horizontal or vertical arrays which is stackable and easy to assembly .

#### **Applications:**

- Computer.
- Communication .
- Industrial.

#### Device Selection Guide

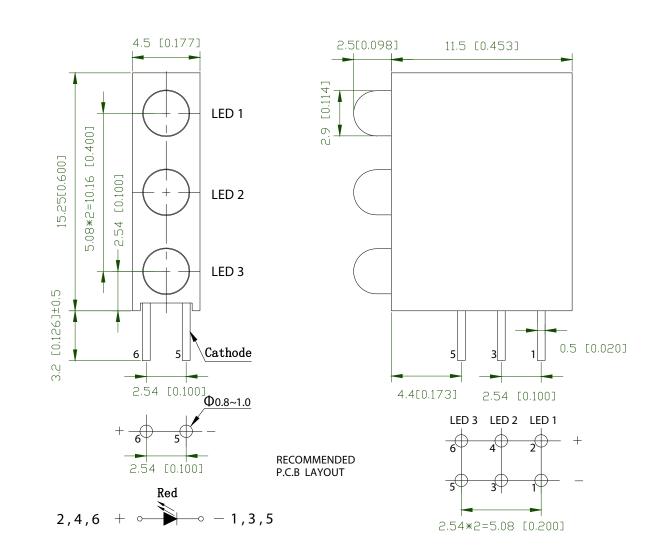
Part No.	Emitting Color	Lens Color (LEDs )
3-22N-CD45R/H3302	Super Bright Red	Red Diffused



3mm Round, Super Bright Red Tri-Level LED CBI

## **Technical Data Sheet**

Package Dimension:



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm\,0.25\,$  mm (.010 ") unless otherwise noted.
- 3. Protruded resin under flange is 1.00mm (.0.39") max.







3mm Round, Super Bright Red Tri-Level LED CBI

# **Technical Data Sheet**

#### Absolute Maximum Ratings at Ta=25 ℃

Parameters	Symbol	Max.	Unit
Power Dissipation	P <sub>d</sub>	60	mW
Peak Forward Current <sup>(a)</sup>	I <sub>FP</sub>	100	mA
DC Forward Current <sup>(b)</sup>	IF	25	mA
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature Range	T <sub>opr</sub>	-40 °C to +	-80°C
Storage Temperature Range	T <sub>stg</sub>	-40 °C to +	-85℃
Soldering Temperature	T <sub>sld</sub>	260 $^\circ\!\mathrm{C}$ for 5 Seconds	

Notes:

a. Derate linearly as shown in derating curve.

b. Duty Factor = 10%, Frequency = 1 kHz.

#### Electrical Optical Characteristics at Ta=25 °C

Parameters	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity <sup>(a)</sup>	lv	160	270		mcd	IF=20mA
Viewing Angle <sup>(b)</sup>	<b>2</b> θ <sub>1/2</sub>		80		deg.	IF=20mA
Peak Emission Wavelength	ур		632		nm	IF=20mA
Dominant Wavelength <sup>(c)</sup>	λd		624		nm	IF=20mA
Spectral Line Half-Width	$ riangle \lambda$		20		nm	IF=20mA
Forward Voltage	VF	1.6	2.0	2.4	V	IF=20mA
Reverse Current	IR			10	μΑ	VR=5V

Notes:

a. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

b.  $2\theta_{1/2}$  is the o-axis angle where the luminous intensity is 1/2 the peak intensity.

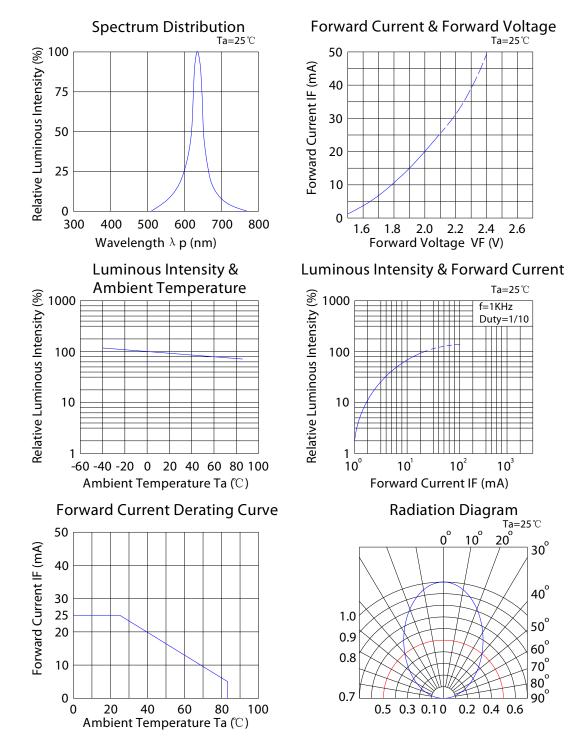
c. The dominant wavelength ( $\lambda$ d) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.



3mm Round, Super Bright Red Tri-Level LED CBI

# **Technical Data Sheet**

Typical Electrical / Optical Characteristics Curves (25 °C Ambient Temperature Unless Otherwise Noted)









3mm Round, Super Bright Red Tri-Level LED CBI

# **Technical Data Sheet**

#### CAUTIONS

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Ever-Led and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- 2.2 Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.
- 3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary .

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 1.6mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming. Lead forming must be done before soldering, at normal temperature. During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, for Lamp without stopper type and must be leave a minimum of 3mm clearance from the base of the lens to the soldering point. Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Solde	ring Iron	Wave S	Soldering
Temperature Soldering Time	300 ℃ Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat Time Solder Wave Soldering Time	100 °C Max. 60 sec. Max. 260 °C Max. 5 sec. Max.

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

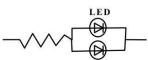
6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A

**Circuit model B** 

LED



# 



## 3-22N-CD45R/H3302

3mm Round, Super Bright Red Tri-Level LED CBI

# **Technical Data Sheet**

(A) Recommended circuit

(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

7. Repairing

9.

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

8. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

8.1. Use a conductive wrist band or anti- electrostatic glove when handling these LEDs.

8.2. All devices, equipment, and machinery must be properly grounded.

8.3. Work tables, storage racks, etc. should be properly grounded.

8.4. Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no light up" at low currents.

To verify for ESD damage, check for "light up" and VF of the suspect LEDs at low currents.

The VF of "good" LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product. Others

- 9.1 The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 9.2 The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 9.3 When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Ever-Led will not be responsible for any subsequent issues.
- 9.4 The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Ever-Led's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health, such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices.